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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Todd O. Bolken

Serial No.: 09/516,080

Filed: March 1, 2000

For: EXPOSED DIE MOLDING
APPARATUS§
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Group Art Unit: 2814

Examiner: Louie, Wai Sing

Atty. Docket: MICS:0043 FLE/MAN
99-0634Mail Stop Non-Fee Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313CERTIFICATE OF TRANSMISSION OR MAILING
37 C.F.R. 1.8

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July 23, 2003

Date

Michael G. Fletcher

Sir:

RESPONSE

In response to the Official Action mailed on April 23, 2003, Applicant respectfully requests reconsideration of the above-identified application in light of the remarks set forth below.

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